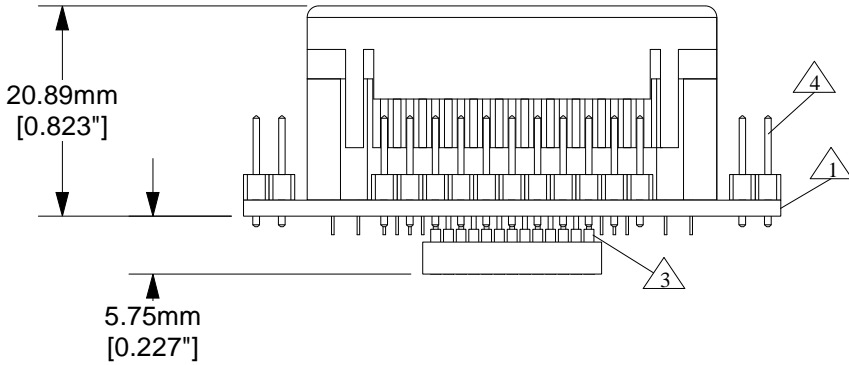


Top View



Side View


- ① Substrate: 1.59mm ±0.18mm [0.0625" ±0.007"] FR4/G10 or equivalent high temp material. 17µm [1/2 oz.] Cu clad. SnPb plating.

- ③ Pins: shell material- Brass Alloy 360 1/2 hard; finish- 0.25µm [10µ"] Au over 1.27µm [50µ"] Ni (min.). Contact material- BeCu; finish 0.25µm [10µ"] Au over 2.54µm [100µ"] Ni (min.).

- ④ Test points: material- Phosphor Bronze; plating- Sn over 1.27µm [50µ"] Ni. Gold flash on contact end.

Description: Carrier Adapter
 84 Position PLCC ZIF Socket with test points to mini-grid array interface.

Tolerances: diameters ±0.03mm [±0.001"], PCB perimeters ±0.13mm [±0.005"], PCB thicknesses ±0.18mm [±0.007"], pitches (from true position) ±0.08mm [±0.003"], all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

	CA-PLCC84-Z-M-T-01 Drawing	Status: Released	Scale: 1:0.75	Rev: A
	© 2001 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing: W. Watson		Date: 11/28/01
		File: CA-PLCC84-Z-M-T-01 Dwg		Modified: